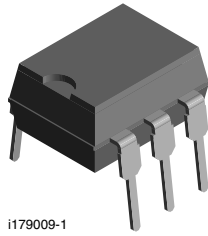
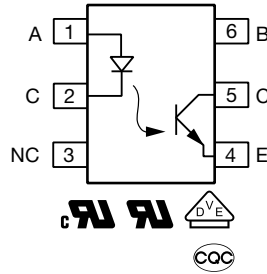




## Optocoupler, Phototransistor Output, no Base Connection



i179009-1



### FEATURES

- Isolation test voltage, 5300 V<sub>RMS</sub>
- No base terminal connection for improved common mode interface immunity
- Long term stability
- Industry standard dual in line package
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



RoHS COMPLIANT

### LINKS TO ADDITIONAL RESOURCES



3D Models



Design Tools



Related Documents



SPICE Models



Footprints



Schematics

### AGENCY APPROVALS

- [UL](#)
- [cUL](#)
- [DIN EN 60747-5-5 \(VDE 0884\)](#), available with option 1
- [BSI EN 62368-1](#)
- [CQC GB4943.1-2011](#)
- [CQC GB8898-2011](#)

### DESCRIPTION

The MOC8101, MOC8102, MOC8103, MOC8104 family optocoupler consisting of a gallium arsenide infrared emitting diode optically coupled to a silicon planar phototransistor detector in a plastic plug-in DIP-6 package. The coupling device is suitable for signal transmission between two electrically separated circuits. The potential difference between the circuits to be coupled should not exceed the maximum permissible reference voltages.

The base terminal of the MOC8101, MOC8102, MOC8103, MOC8104 is not connected, resulting in a substantially improved common mode interference immunity.

ORDERING INFORMATION														
M	O	C	8	1	0	#	-	#	X	0	#	#	T	
PART NUMBER						CTR BIN		PACKAGE OPTION				TAPE AND REEL		
AGENCY CERTIFIED / PACKAGE		CTR (%)												
		10 mA												
UL, cUL, BSI, CQC		50 to 80	73 to 117	108 to 173	160 to 256									
DIP-6		MOC8101	MOC8102	MOC8103	MOC8104									
DIP-6, 400 mil, option 6		-	MOC8102-X006	-	-									
SMD-6, option 9		-	MOC8102-X009 <sup>(1)</sup>	-	-									
UL, cUL, BSI, CQC, VDE (Option 1)		50 to 80	73 to 117	108 to 173	160 to 256									
DIP-6		-	-	MOC8103-X001	-									
DIP-6, 400 mil		-	MOC8102-X016	-	MOC8104-X016									
SMD-6, option 7		MOC8101-X017T	MOC8102-X017T <sup>(1)</sup>	-	-									
SMD-6, option 9		-	-	-	MOC8104-X019T									

### Notes

- Additional options may be possible, please contact sales office
- <sup>(1)</sup> Also available in tubes; do not put T on end



<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
<b>INPUT</b>				
Reverse voltage		$V_R$	6.0	V
Forward continuous current		$I_F$	60	mA
Surge forward current	$t \leq 10\text{ }\mu\text{s}$	$I_{FSM}$	2.5	A
Power dissipation		$P_{diss}$	100	mW
Derate linearly from 25°C			1.33	mW/°C
<b>OUTPUT</b>				
Collector emitter breakdown voltage		$BV_{CEO}$	30	V
Emitter collector breakdown voltage		$BV_{ECO}$	7.0	V
Collector current		$I_C$	50	mA
Derate linearly from 25°C			2.0	mW/°C
Power dissipation		$P_{diss}$	150	mW
<b>COUPLER</b>				
Derate linearly from 25 °C			3.33	mW/°C
Total power dissipation		$P_{tot}$	250	mW
Storage temperature		$T_{stg}$	-55 to +150	°C
Operating temperature		$T_{amb}$	-55 to +100	°C
Junction temperature		$T_j$	100	°C
Soldering temperature <sup>(1)</sup>	max. 10 s, dip soldering: distance to seating plane $\geq 1.5\text{ mm}$	$T_{slid}$	260	°C

**Notes**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability
- <sup>(1)</sup> Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP)

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT</b>							
Forward voltage	$I_F = 10\text{ mA}$		$V_F$	-	1.25	1.5	V
Breakdown voltage	$I_R = 10\text{ }\mu\text{A}$		$V_{BR}$	6.0	-	-	V
Reverse current	$V_R = 6.0\text{ V}$		$I_R$	-	0.01	10	$\mu\text{A}$
Capacitance	$V_R = 0\text{ V}$ , $f = 1.0\text{ MHz}$		$C_O$	-	25	-	pF
Thermal resistance			$R_{thja}$	-	750	-	K/W
<b>OUTPUT</b>							
Collector emitter capacitance	$V_{CE} = 5.0\text{ V}$ , $f = 1.0\text{ MHz}$		$C_{CE}$	-	5.2	-	pF
Collector emitter dark current	$V_{CE} = 10\text{ V}$ , $T_{amp} = 25\text{ }^{\circ}\text{C}$	MOC8101	$I_{CEO1}$	-	1.0	50	nA
	$V_{CE} = 10\text{ V}$ , $T_{amp} = 100\text{ }^{\circ}\text{C}$	MOC8102	$I_{CEO1}$	-	1.0	-	$\mu\text{A}$
Collector emitter breakdown voltage	$I_C = 1.0\text{ mA}$		$BV_{CEO}$	30	-	-	V
Emitter collector breakdown voltage	$I_E = 100\text{ }\mu\text{A}$		$BV_{ECO}$	7.0	-	-	V
Thermal resistance			$R_{thja}$	-	500	-	K/W
<b>COUPLER</b>							
Saturation voltage collector emitter	$I_F = 5.0\text{ mA}$		$V_{CEsat}$	-	0.25	0.4	V
Coupling capacitance			$C_C$	-	0.6	-	pF

**Note**

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements



<b>CURRENT TRANSFER RATIO</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio	$V_{CE} = 10\text{ V}$ , $I_F = 10\text{ mA}$	MOC8101	CTR	50	-	80	%
		MOC8102	CTR	73	-	117	%
		MOC8103	CTR	108	-	173	%
		MOC8104	CTR	160	-	256	%

<b>SWITCHING CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Turn-on time	$V_{CC} = 10\text{ V}$ , $I_C = 2.0\text{ mA}$ , $R_L = 100\text{ }\Omega$	$t_{on}$	-	3.0	-	$\mu\text{s}$	
Turn-off time	$V_{CC} = 10\text{ V}$ , $I_C = 2.0\text{ mA}$ , $R_L = 100\text{ }\Omega$	$t_{off}$	-	2.3	-	$\mu\text{s}$	
Rise time	$V_{CC} = 10\text{ V}$ , $I_C = 2.0\text{ mA}$ , $R_L = 100\text{ }\Omega$	$t_r$	-	2.0	-	$\mu\text{s}$	
Fall time	$V_{CC} = 10\text{ V}$ , $I_C = 2.0\text{ mA}$ , $R_L = 100\text{ }\Omega$	$t_f$	-	2.0	-	$\mu\text{s}$	
Cut off frequency		$f_{co}$	-	250	-	kHz	

<b>SAFETY AND INSULATION RATINGS</b>				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		55 / 100 / 21	
Comparative tracking index		CTI	175	
Maximum rated withstanding isolation voltage	$t = 1\text{ min}$	$V_{ISO}$	4420	$V_{RMS}$
Maximum transient isolation voltage		$V_{IOTM}$	10 000	V
Maximum repetitive peak isolation voltage		$V_{IORM}$	890	V
Isolation resistance	$V_{IO} = 500\text{ V}$ , $T_{amb} = 25\text{ }^{\circ}\text{C}$	$R_{IO}$	$\geq 10^{12}$	$\Omega$
	$V_{IO} = 500\text{ V}$ , $T_{amb} = 100\text{ }^{\circ}\text{C}$	$R_{IO}$	$\geq 10^{11}$	$\Omega$
Output safety power		$P_{SO}$	400	mW
Input safety current		$I_{SI}$	275	mA
Input safety temperature		$T_{SI}$	175	$^{\circ}\text{C}$
Creepage distance	Standard DIP-6		$\geq 7$	mm
Clearance distance	Standard DIP-6		$\geq 7$	mm
Creepage distance	400 mil DIP-6		$\geq 8$	mm
Clearance distance	400 mil DIP-6		$\geq 8$	mm
Insulation thickness		DTI	$\geq 0.4$	mm

**Note**

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits



**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

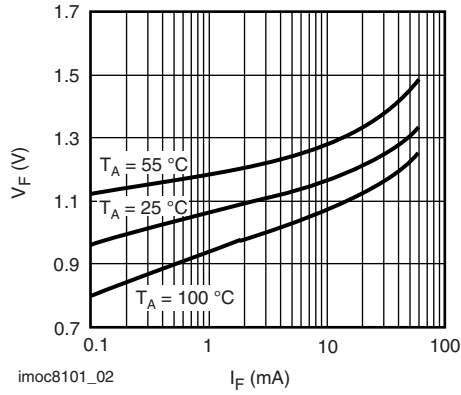


Fig. 1 - Forward Voltage vs. Forward Current

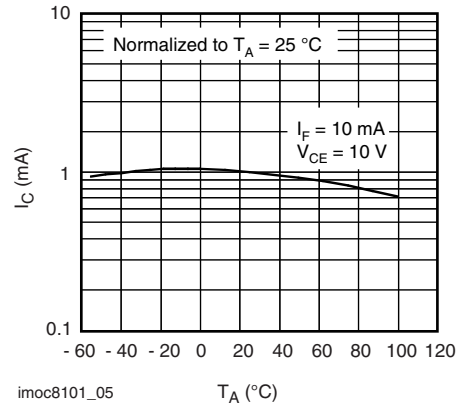


Fig. 4 - Collector Current vs. Ambient Temperature

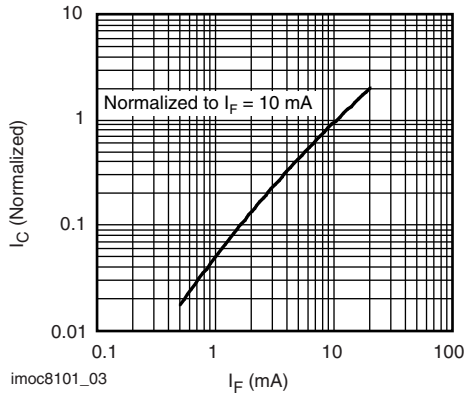


Fig. 2 - Collector Current vs. LED Forward Current

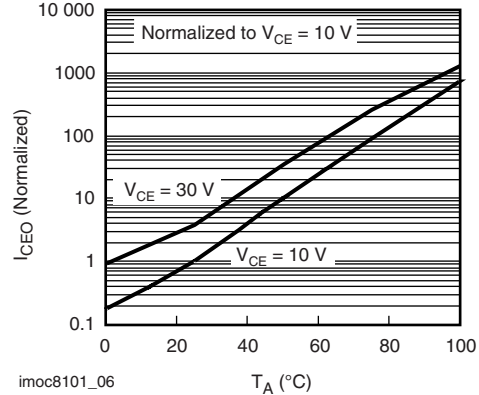


Fig. 5 - Collector Emitter Dark Current vs. Ambient Temperature

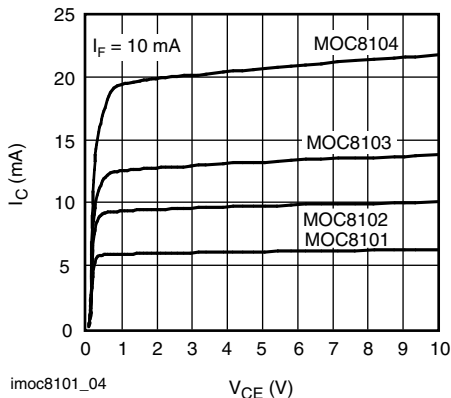


Fig. 3 - Collector Current vs. Collector Emitter Voltage

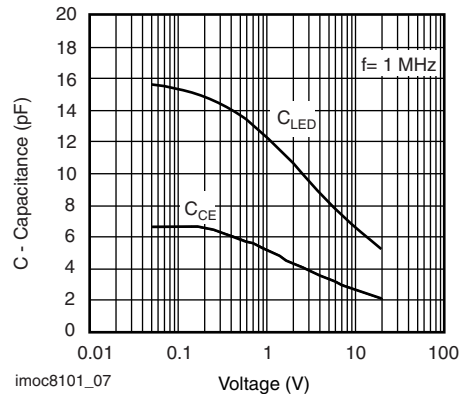


Fig. 6 - Capacitance vs. Voltage

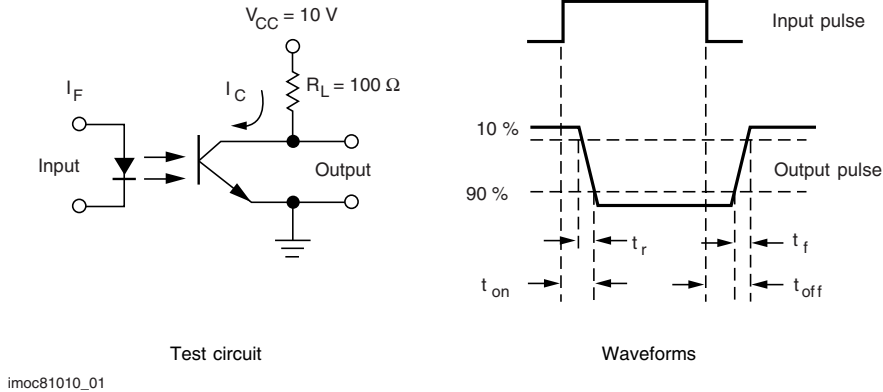
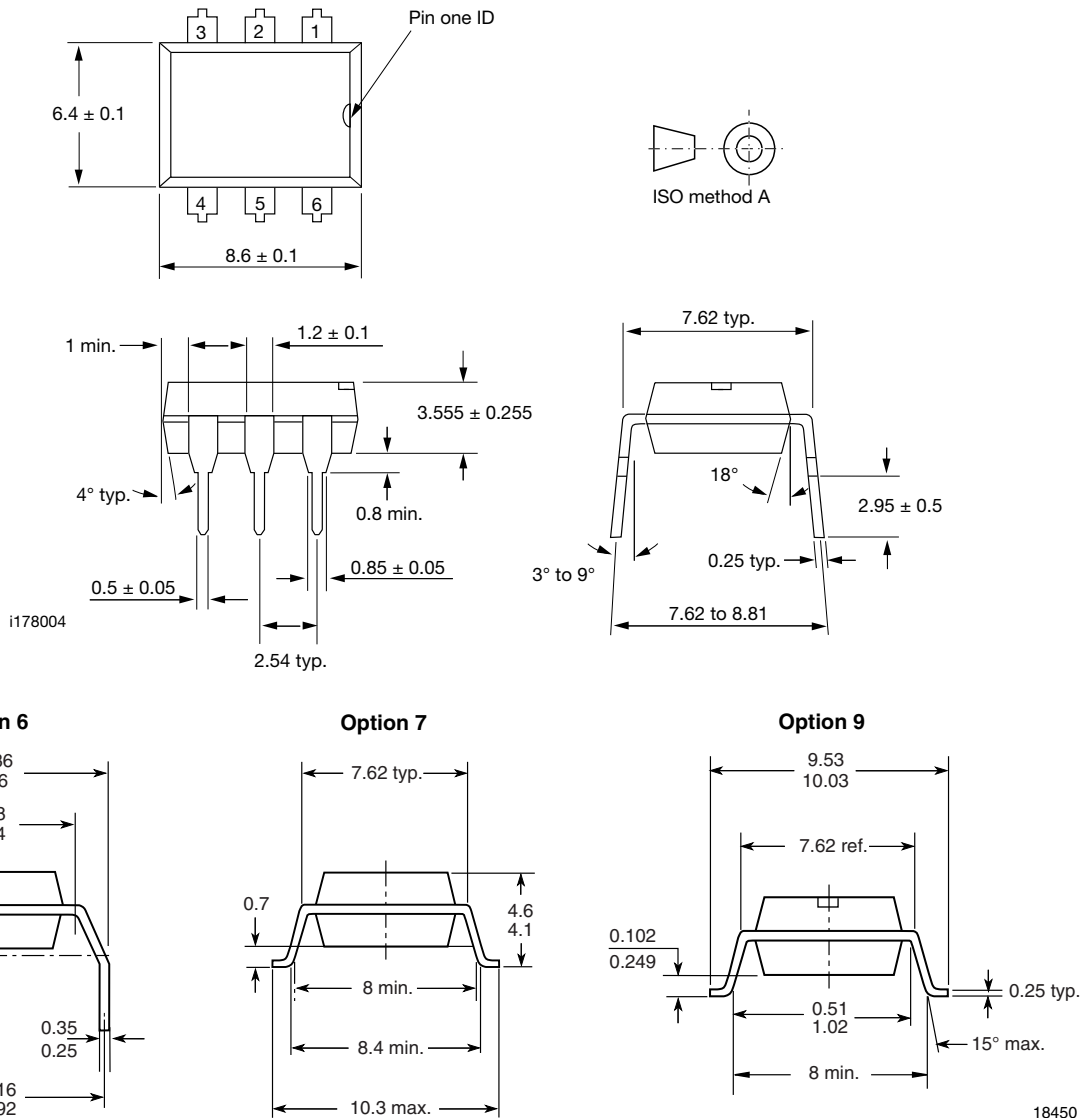


Fig. 7 - Switching Time Test Circuit and Waveforms

## PACKAGE DIMENSIONS in millimeters





## PACKAGE MARKING (example)

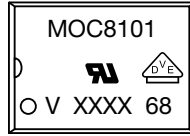


Fig. 8 - Example of MOC8101-X017T

### Notes

- XXXX = LMC (lot marking code)
- VDE logo is only marked on option 1 parts
- Tape and reel suffix (T) is not part of the package marking



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